



Product data sheet

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a TO220 plastic package intended for use in applications requiring very high inrush current capability, high thermal cycling performance and high junction temperature capability ($T_{j(max)} = 150$ °C).

2. Features and benefits

- High junction operating temperature capability (T_{i(max)} = 150 °C)
- Very high current surge capability
- Planar passivated for voltage ruggedness and reliability
- High turn-on current rise $dI_T/dt = 100 A/\mu s$
- High noise immunity dV_D/dt = 500 V/µs up to 150 °C
- High thermal cycling performance
- High voltage capability

3. Applications

- Ignition circuits
- Protection circuits e.g. SMPS inrush current
- Motor control circuits and starters
- Voltage regulation
- Solid state relays
- High junction operating temperature capability (T_{j(max)} = 150 °C)

4. Quick reference data

Table 1. Quic	k reference data			
Symbol	Parameter	Conditions	Values	Unit
Absolute m	aximum rating		·	
V_{DRM}	repetitive peak off-state voltage		800	V
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 128°C; <u>Fig. 1; Fig. 2; Fig. 3</u>	40	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	450	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	495	A
Tj	junction temperature		150	°C

Symbol	Parameter	Conditions		Min	Тур	Max	Unit	
Static cha	Static characteristics							
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		-	-	15	mA	
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA	
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 10</u>		-	-	1.6	V	
Dynamic	Dynamic characteristics							
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T _j = 150 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit		500	-	-	V/µs	

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode		А К G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information							
Type number	Package Name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date	
TYN40-800T	TO220	TYN40-800TQ	Tube	50	SOT78	13-Jun-2008	

PJdxxxx xx

7. Marking

Table 4. Marking codes Type number Marking codes Assembly factory: d Assembly factory: A TYN40-800T TYN40 800T

TYN40

800T

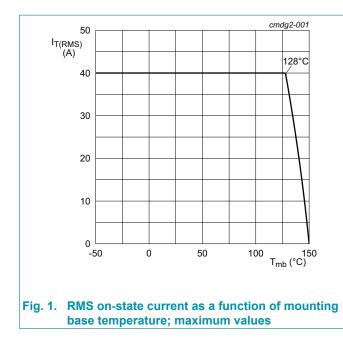
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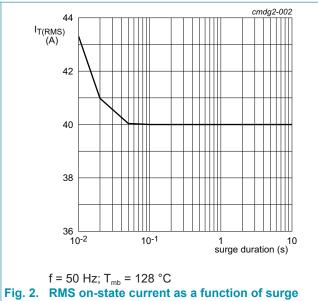
8. Limiting values

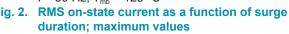
Table 5. Limiting values

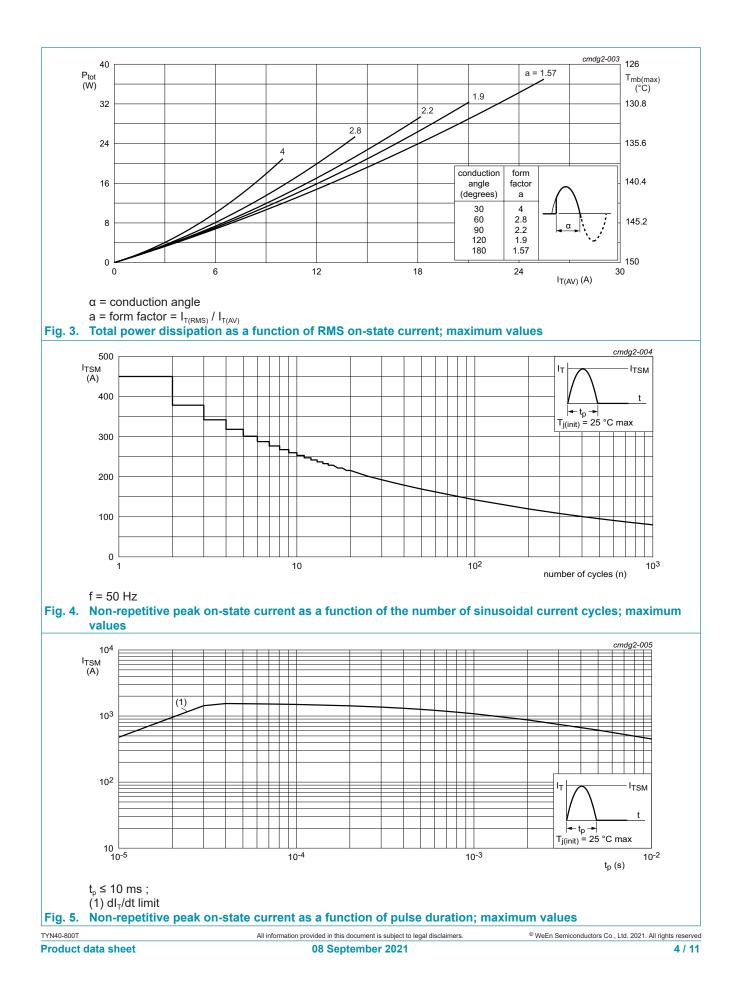
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Values	Unit
V _{drm}	repetitive peak off-state voltage		800	V
V_{RRM}	repetitive peak reverse voltage		800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 128°C;	25	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 128°C; <u>Fig. 1; Fig. 2; Fig. 3</u>	40	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; Fig. 4; Fig. 5	450	A
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms	495	A
l ² t	l ² t for fusing	t _p = 10ms; sine wave	1012.5	A ² s
dl⊤/dt	rate of rise of on-state current	I _G = 30mA	100	A/µs
I _{GM}	peak gate current		5	А
V _{GM}	peak gate voltage		5	V
P _{GM}	peak gate power		20	W
P _{G(AV)}	average gate power	over any 20 ms period	0.5	W
T _{stg}	storage temperature		-40 to 150	°C
Tj	junction temperature		150	°C



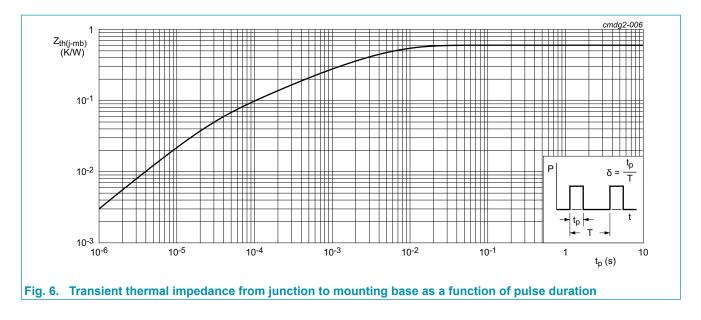






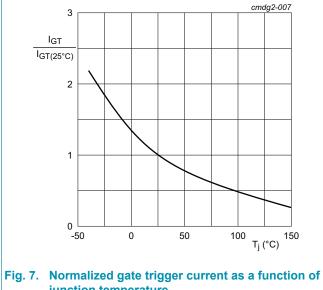
9.	Thermal	characteristics

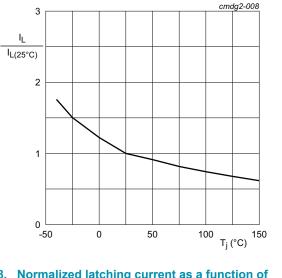
able 6. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{\text{th(j-mb)}}$	thermal resistance from junction to mounting base	<u>Fig. 6</u>		-	-	0.6	K/W
$R_{\text{th(j-a)}}$	thermal resistance from junction to ambient free air	in free air		-	60	-	K/W



10. Characteristics

Table 7. Ch	aracteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Static cha	racteristics						
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		-	-	15	mA
IL	latching current	$V_{\rm D}$ = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>		-	-	80	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>		-	-	60	mA
V _T	on-state voltage	I _T = 80 A; T _j = 25 °C; <u>Fig. 10</u>		-	-	1.6	V
V_{GT}	gate trigger voltage	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; T_{j} = 25 \text{ °C};$ Fig. 11		-	0.7	1.2	V
		V _D = 400 V; I _T = 0.1 A; T _j = 150 °C		0.25	0.5	-	V
I _D	off-state current	V _D = 800 V; T _j = 150 °C		-	-	2	mA
I _R	reverse current	V _D = 800 V; T _j = 150 °C		-	-	2	mA
Dynamic o	haracteristics	· ·	I				,
dV _D /dt	rate of rise of off-state voltage	$V_{DM} = 536 \text{ V}; \text{ T}_{j} = 150 \text{ °C}; (V_{DM} = 67\% \text{ of } V_{DRM});$ exponential waveform; gate open circuit		500	-	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 80 \text{ A}; V_D = 800 \text{ V}; I_G = 100 \text{ mA};$ $(dI_G/dt)_M = 0.2 \text{ A}/\mu\text{s}; T_j = 25 \text{ °C}$			2	-	μs
t _q	commutated turn-off time				70	-	μs

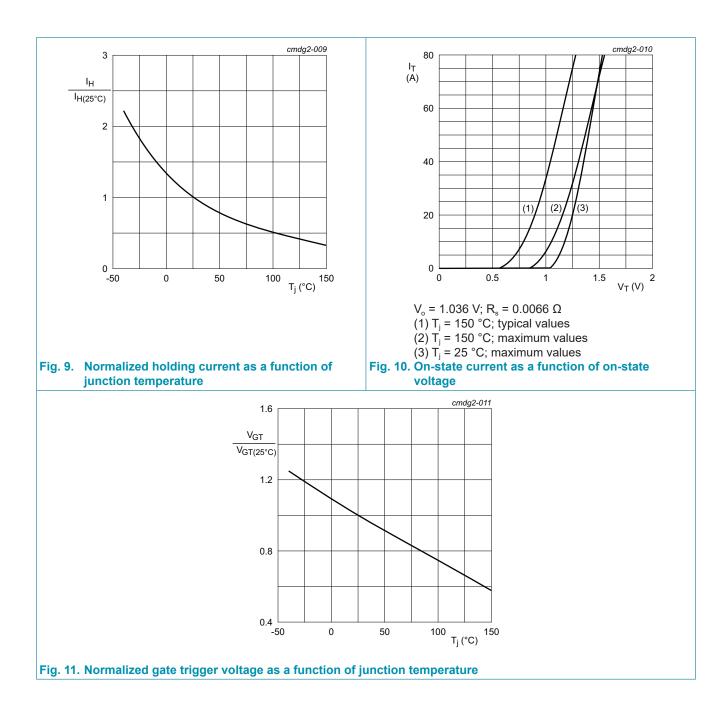






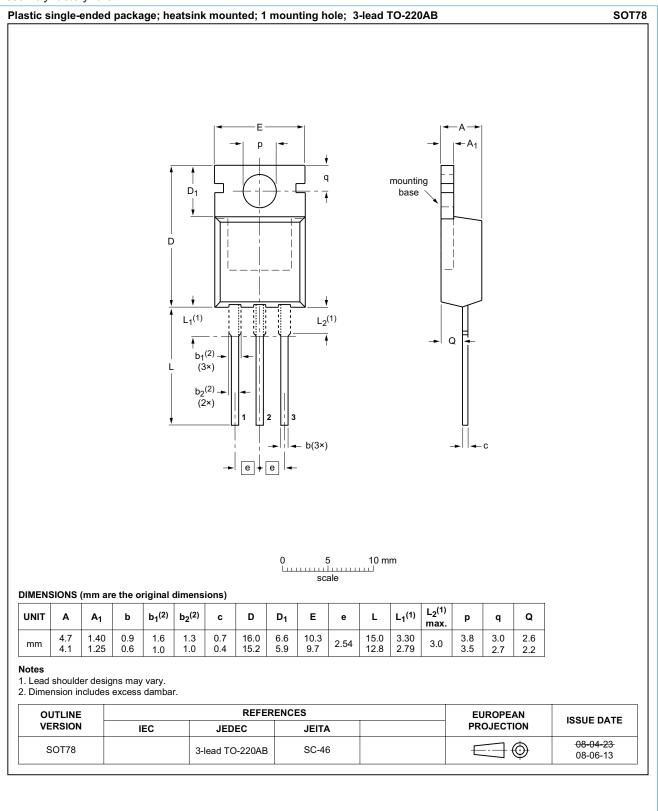


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11. Package outline

Assembly factory: d & A



12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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